# 176153-4 - ACTIVE

TE Internal #: 176153-4 PCB Mount Header, Horizontal, Wire-to-Board, 4 Position, 2.5 mm [. 098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural

### View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Horizontal

## Features

## Product Type Features

Connector System	Wire-to-Board			
Header Type	Partially Shrouded			
Sealable	No			
Connector & Contact Terminates To	Printed Circuit Board			
PCB Connector Assembly Type	PCB Mount Header			
Configuration Features				
Number of Positions	4			
Number of Rows	1			
PCB Mount Orientation	Horizontal			
Electrical Characteristics				
Operating Voltage	250 VAC			
Body Features				
Connector Profile	Standard			
Primary Product Color	Natural			

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## **Contact Features**

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**C** For support call+1 800 522 6752

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Circuit Application	Signal
ndustry Standards	
Agency/Standard	UL
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500
Packaging Type	Bag, Box
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	
EU REACH Regulation (EC) No. 1907/2006	No Restricted Materials Above Threshold
	Current ECHA Candidate List: JUNE 2023
	Current ECHA Candidate List: JUNE 2023 (235)
	Current ECHA Candidate List: JUNE 2023 (235)
	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023
Halogen Content	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233)

homogenous material. Also BFR/CFR/PVC Free

### Solder Process Capability

Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

PCB Mount Header, Horizontal, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural





## Customers Also Bought



CRG1206 1% 470R	W33-S1N1Q-10=W33	2.0MM PITCH CRIMP HOUSING 16P	SRCA 1,27 8 M 1 SMD 137 E1 09 GURT *



## Documents

Product Drawings EIS POST HDR ASSY H 4P GOLD

English

## **CAD** Files

## 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_176153-4\_B.2d\_dxf.zip

PCB Mount Header, Horizontal, Wire-to-Board, 4 Position, 2.5 mm [.098 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder, Signal, Natural



English

Customer View Model ENG\_CVM\_CVM\_176153-4\_B.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_176153-4\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages 1-1773972-5\_EIS\_Connectors\_Brochure

English

Product Specifications Crimping of AMP EI Series Connector Contacts

Japanese

**Application Specification** 

Japanese

Product Environmental Compliance MD\_176153-4\_1207201117

English

MD\_176153-4\_1207201117

English